

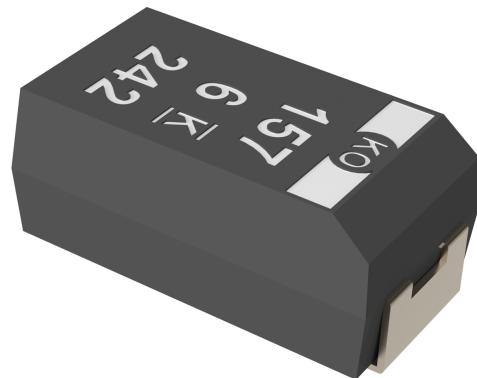
Overview

The KEMET Organic Capacitor (KO-CAP) is a tantalum capacitor with a Ta anode and Ta_2O_5 dielectric. A conductive organic polymer replaces the traditionally used MnO_2 as the cathode plate of the capacitor. This results in very low ESR and improved capacitance retention at high frequency. The KO-CAP also exhibits a benign failure mode which eliminates the ignition failures that can occur in standard MnO_2 tantalum types.

KO-CAPs may also be operated at steady state voltages up to 90% of rated voltage for part types with rated voltages of ≤ 10 . The T522 Reduced Leakage Polymer Tantalum Series is designed to meet the needs of leakage-sensitive applications such as battery supported circuits. The T522 Series offers the lowest leakage values available in polymer tantalum capacitors with upper leakage limits that are up to 70% lower than other polymer series.

Benefits

- ESR: 25 to 40 mΩ
- -55°C to 105°C operating temperature range
- Polymer cathode technology
- High frequency capacitance retention
- Non-ignition failure mode
- Capacitance: 150 to 470 μF
- Voltage: 6.3 V
- 100% accelerated steady state aging
- 100% surge current tested
- Low profile designs
- Volumetric efficiency
- Self-healing mechanism
- EIA standard case sizes



Applications

Typical applications include battery-dependent applications such as handheld consumer electronics, global tracking systems, energy harvesting, wireless sensors and other applications that seek high capacitance, low profile, safety and low power consumption.

Environmental Compliance

RoHS Compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder.



RoHS Compliant

SPICE

For a detailed analysis of specific part numbers, please visit www.kemet.com for a free download of KEMET's SPICE software. The KEMET SPICE program is freeware intended to aid design engineers in analyzing the performance of these capacitors over frequency, temperature, ripple, and DC bias conditions.

Ordering Information

T	522	V	157	M	006	A	T	E025	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Failure Rate/Design	Lead Material	ESR Code	Packaging (C-Spec)
T = Tantalum	522 = Reduced Leakage Polymer	V, Y	First two digits represent significant figures. Third digit specifies number of zeros.	M = $\pm 20\%$	006 = 6.3 V	A = N/A	T = 100% Matte Tin (Sn) Plated H = Tin/Lead (SnPb) Solder Coated (5% Pb minimum)	E = ESR Last three digits specify ESR in m Ω . (025 = 25 m Ω)	Blank = 7" Reel 7280 = 13" Reel

Performance Characteristics

Item	Performance Characteristics
Operating Temperature	-55°C to 105°C
Rated Capacitance Range	150 – 470 uF @ 120 Hz/25°C
Capacitance Tolerance	M Tolerance (20%)
Rated Voltage Range	6.3 V
DF (120 Hz)	$\leq 10\%$
ESR (100 kHz)	Refer to Part Number Electrical Specification Table 1
Leakage Current	≤ 0.03 CV (μ A) at rated voltage after 10 minutes

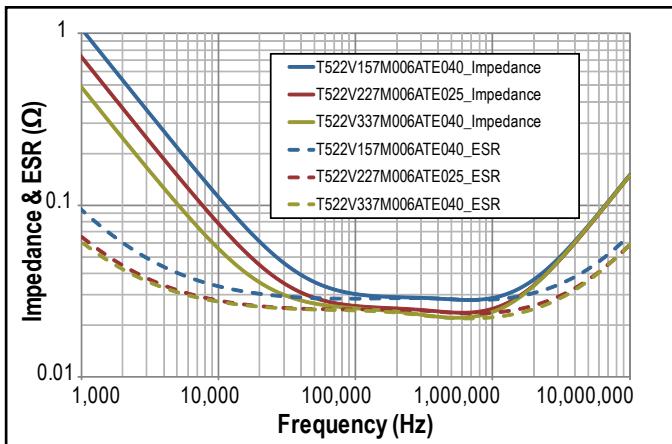
Qualification

Test	Condition	Characteristics			
Endurance	105°C @ rated voltage, 2,000 hours	Δ C/C	Within -20/+10% of initial value		
		DF	Within initial limits		
		DCL	Within 1.5 x initial limit		
		ESR	Within 2.0 x initial limit		
Storage Life	105°C @ 0 volts, 2,000 hours	Δ C/C	Within -20/+10% of initial value		
		DF	Within initial limits		
		DCL	Within 1.5 x initial limit		
		ESR	Within 2.0 x initial limit		
Humidity	60°C, 90% RH, 500 hours, rated voltage	Δ C/C	Within -5%/+35% of initial value		
		DF	Within initial limits		
		DCL	Within 5.0 x initial limit		
		ESR	Within 2.0 x initial limit		
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C, -55°C, +25°C, +85°C, +105°/125°C, +25°C	+25°C	-55°C	+85°C	+105°C
		Δ C/C	IL*	±20%	±20%
		DF	IL	IL	1.2 x IL
		DCL	IL	n/a	10 x IL
Surge Voltage	105°C, 1.32 x rated voltage, 33 Ω Resistance, 1,000 cycles	Δ C/C	Within -20%/+10% of initial value		
		DF	Within initial limits		
		DCL	Within initial limits		
		ESR	Within initial limits		
Mechanical Shock/Vibration	MIL-STD-202, Method 213, Condition I, 100 G peak. MIL-STD-202, Method 204, Condition D, 10 Hz to 2,000 Hz, 20 G peak	Δ C/C	Within ±10% of initial value		
		DF	Within initial limits		
		DCL	Within initial limits		

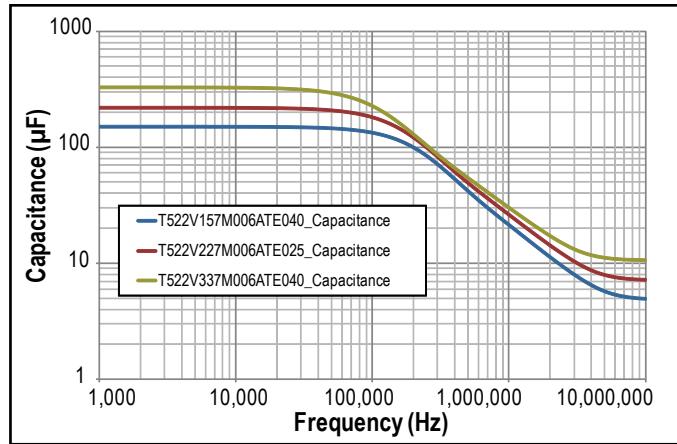
*IL = Initial limit

Electrical Characteristics

Impedance & ESR vs. Frequency

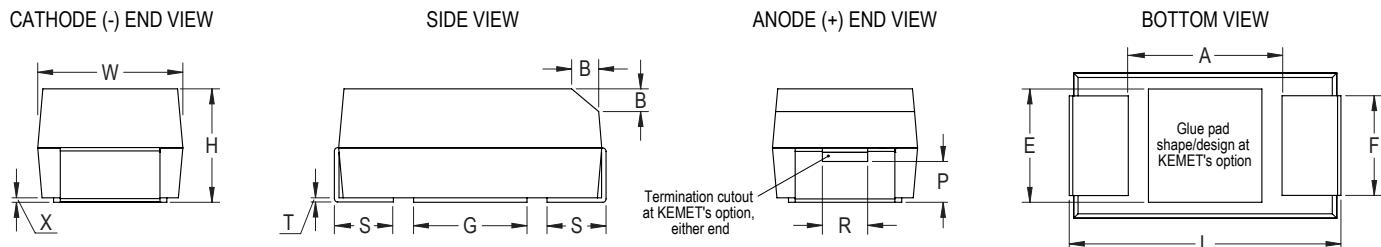


Capacitance vs. Frequency



Dimensions – Millimeters (Inches)

Metric will govern



Case Size		Component												
KEMET	EIA	L*	W*	H*	F* \pm 0.1 \pm (.004)	S* \pm 0.3 \pm (.012)	B* \pm 0.15 (Ref) \pm .006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
V	7343-19	7.3 \pm 0.3 (0.287 \pm 0.012)	4.3 \pm 0.3 (0.169 \pm 0.012)	1.9 (.075)	2.4 (.094)	1.3 (.051)	n/a	0.05 (.002)	n/a	n/a	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
Y	7343-40	7.3 \pm 0.3 (0.287 \pm 0.012)	4.3 \pm 0.3 (0.169 \pm 0.012)	4.0 (.157) maximum	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 \pm 0.10 (.004 \pm .004)	1.7 (.067)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)

Notes: (Ref) – Dimensions provided for reference only. No dimensions are provided for B, P or R because low profile cases do not have a bevel or a notch.

* MIL-PRF-55365/8 specified dimensions

Table 1 – Ratings & Part Number Reference

Rated Voltage	Rated Capacitance	Case Code/Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current	Moisture Sensitivity	Rated Temp
VDC	µF	KEMET/EIA	(See below for part options)	µA @ +20°C Max/10 Min.	% @ +20°C 120 Hz Max	mΩ @ +20°C 100 kHz Max	(mA) +45°C 100 kHz	Temperature ≤ 260°C	(°C)
6.3	150	V/7343-19	T522V157M006A(1)E025	28	10	25	2700	3	105
6.3	150	V/7343-19	T522V157M006A(1)E040	28	10	40	2200	3	105
6.3	220	V/7343-19	T522V227M006A(1)E025	42	10	25	2700	3	105
6.3	220	V/7343-19	T522V227M006A(1)E040	42	10	40	2200	3	105
6.3	330	V/7343-19	T522V337M006A(1)E040	62	10	40	2200	3	105
6.3	470	Y/7343-40	T522Y477M006A(1)E035	89	10	35	2600	3	105

(1) Standard with tin terminations (14th character = T). Tin/lead terminations is also available (14th character = H).

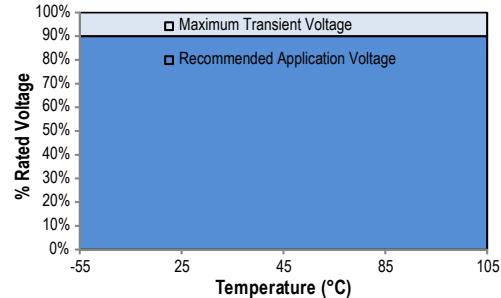
Also available on large (13 inch) reels. Add 7280 to the end of the part number.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitutions will be marked with the higher voltage rating. Substitutions can include better than series.

Derating Guidelines

Voltage Rating	Maximum Recommended Steady State Voltage	Maximum Recommended Transient Voltage (1 ms – 1 μ s)
-55°C to 105°C		
6.3 V	90% of V_R	V_R

V_R = Rated Voltage



Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

KEMET Series and Case Code	EIA Case Code	Maximum Power Dissipation (P max) mWatts @ 45°C with +30°C Rise
T520T	3528-12	105
T520M	3528-15	120
T520A	3216-18	112
T520B	3528-21	127
T520U	6032-15	135
T520L	6032-19	150
T520C	6032-28	165
T520W	7343-15	180
T520V / T522V	7343-19	187
T520Q	7343-12	170
T520D	7343-31	225
T520Y / T522Y	7343-40	241
T520X	7343-43	247
T520H	7360-20	187

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

Temperature Compensation Multipliers for Maximum Ripple Current		
T ≤ 45°C	45°C < T ≤ 85°C	85°C < T ≤ 125°C
1.00	0.70	0.25

T = Environmental Temperature

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I_{(max)} = \sqrt{P_{max}/R}$$

$$E_{(max)} = Z \sqrt{P_{max}/R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

P max = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)

Reverse Voltage

Polymer tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected in the wrong polarity. These devices will withstand a small degree of transient voltage reversal for short periods as shown in the below table.

Temperature	Permissible Transient Reverse Voltage
25°C	15% of Rated Voltage
55°C	10% of Rated Voltage
85°C	5% of Rated Voltage
105°C	3% of Rated Voltage
125°C*	1% of Rated Voltage

*For series rated to 125°C

Table 2 – Land Dimensions/Courtyard

KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)				
		Case	EIA	W	L	S	V1	V2	W	L	S	V1	V2	W	L	S
V	7343-20	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84
Y ¹	7343-40	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84

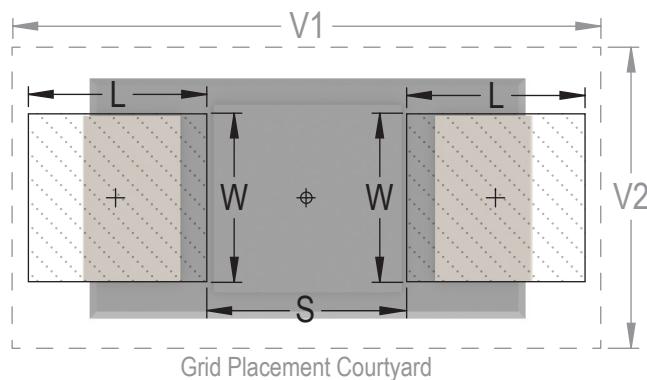
Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

¹ Height of these chips may create problems in wave soldering.

² Land pattern geometry is too small for silkscreen outline.



Soldering Process

KEMET's families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Please note that although the X/7343–43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. "Wiping" the edges of a chip and heating the top surface is not recommended.

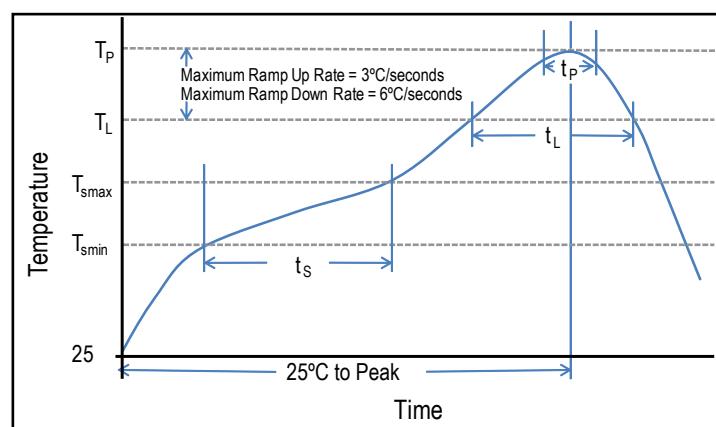
During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

Profile Feature	SnPb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Minimum (T_{smin})	100°C	150°C
Temperature Maximum (T_{smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax})	60 – 120 seconds	60 – 120 seconds
Ramp-up Rate (T_L to T_p)	3°C/seconds maximum	3°C/seconds maximum
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T_p)	220°C* 235°C**	250°C* 260°C**
Time within 5°C of Maximum Peak Temperature (t_p)	20 seconds maximum	30 seconds maximum
Ramp-down Rate (T_p to T_L)	6°C/seconds maximum	6°C/seconds maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

*Case Size D, E, P, Y, and X

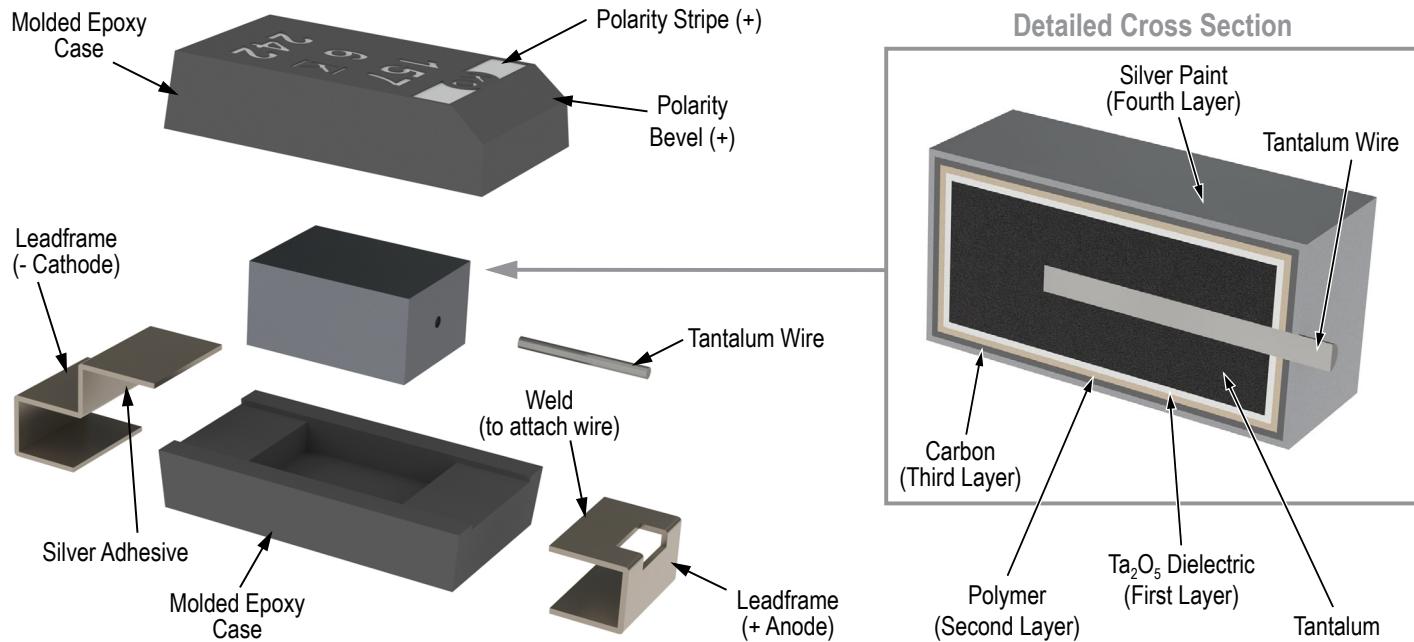
**Case Size A, B, C, H, I, K, M, R, S, T, U, V, W, and Z



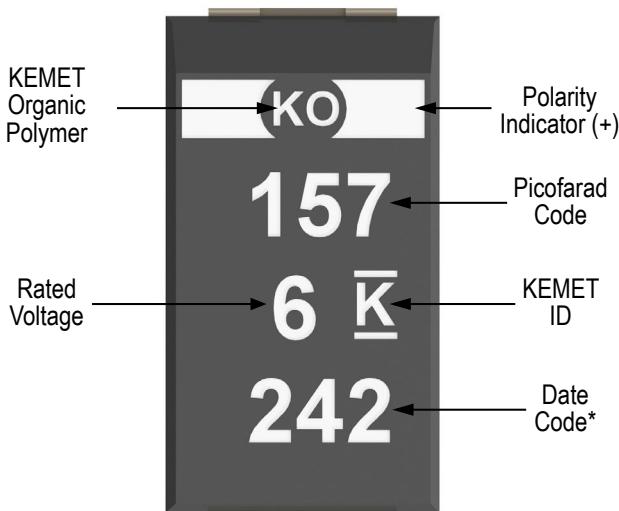
Storage

All KO-CAP Series are shipped in moisture barrier bags with a desiccant and moisture indicator card. This series is classified as MSL3 (Moisture Sensitivity Level 3). Product contained within the moisture barrier bags should be stored in normal working environments with temperatures not to exceed 40°C and humidity not in excess of 60% RH.

Construction



Capacitor Marking



* 242 = 42nd week of 2012

Date Code *	
1 st digit = Last number of Year	9 = 2009 0 = 2010 1 = 2011 2 = 2012 3 = 2013 4 = 2014
2 nd and 3 rd digit = Week of the Year	01 = 1 st week of the Year to 52 = 52 nd week of the Year

Tape & Reel Packaging Information

KEMET's molded tantalum and aluminum chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481: Embossed Carrier Taping of Surface Mount Components for Automatic Handling*. This packaging system is compatible with all tape-fed automatic pick-and-place systems.

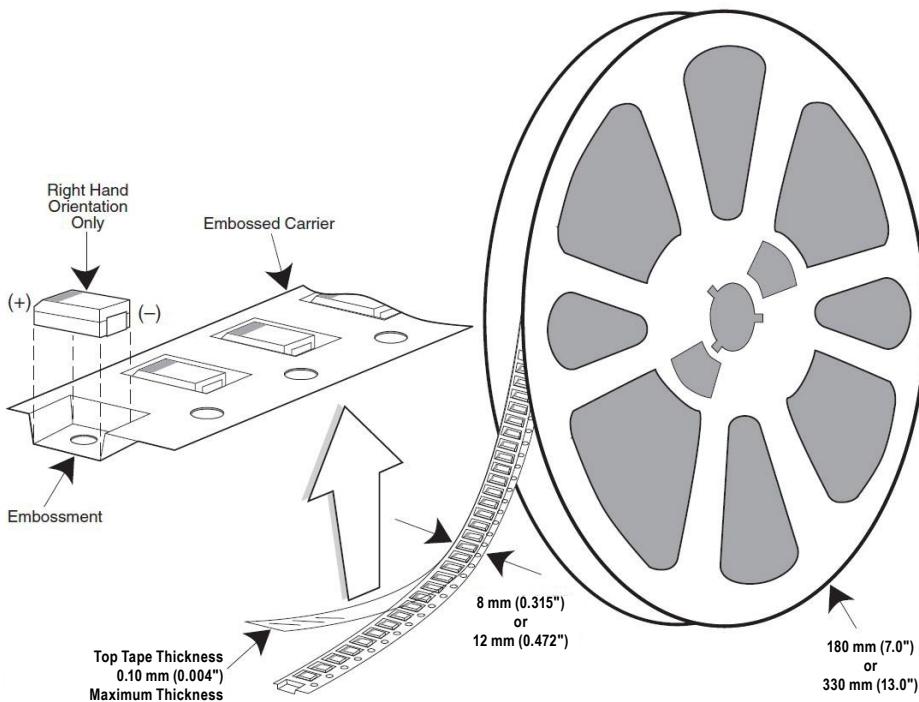


Table 3 – Packaging Quantity

Case Code		Tape Width (mm)	7" Reel*	13" Reel*
KEMET	EIA			
R	2012-12	8	2,500	10,000
I	3216-10	8	3,000	12,000
S	3216-12	8	2,500	10,000
T	3528-12	8	2,500	10,000
M	3528-15	8	2,000	8,000
U	6032-15	12	1,000	5,000
L	6032-19	12	1,000	5,000
W	7343-15	12	1,000	3,000
Z	7343-17	12	1,000	3,000
V	7343-19	12	1,000	3,000
A	3216-18	8	2,000	9,000
B	3528-21	8	2,000	8,000
C	6032-28	12	500	3,000
D	7343-31	12	500	2,500
Y	7343-40	12	500	2,000
X	7343-43	12	500	2,000
E/T428P	7360-38	12	500	2,000
H	7360-20	12	1,000	2,500

* No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.

Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

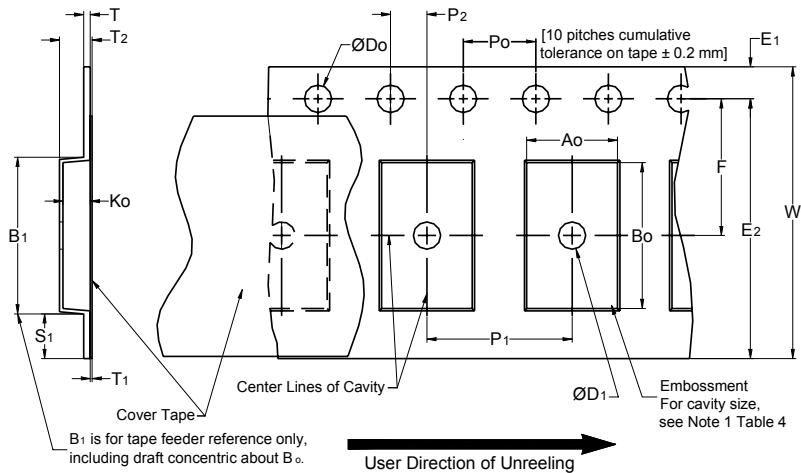


Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D_0	D_1 Minimum Note 1	E_1	P_0	P_2	R Reference Note 2	S_1 Minimum Note 3	T Maximum	T_1 Maximum
8 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)				30			
16 mm					2.0 ±0.1 (0.079 ±0.059)				

Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	B_1 Maximum Note 4	E_2 Minimum	F	P_1	T_2 Maximum	W Maximum	A_0 , B_0 & K_0	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	2.0 ±0.05 or 4.0 ±0.10 (0.079 ±0.002 or 0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)	Note 5	
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	2.0 ±0.05 (0.079 ±0.002) or 4.0 ±0.10 (0.157 ±0.004) or 8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)		
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.10 (0.295 ±0.004)	4.0 ±0.10 (0.157 ±0.004) to 12.0 ±0.10 (0.472 ±0.004)	8.0 (0.315)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
2. The tape, with or without components, shall pass around R without damage (see Figure 4).
3. If $S_1 < 1.0$ mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481-D, paragraph 4.3, section b).
4. B_1 dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A_0 , B_0 and K_0 shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 2).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 3).
 - (e) see Addendum in EIA Standard 481-D for standards relating to more precise taping requirements.

Packaging Information Performance Notes

1. Cover Tape Break Force: 1.0 Kg minimum.

2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 \pm 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to *EIA Standards 556 and 624*.

Figure 2 – Maximum Component Rotation

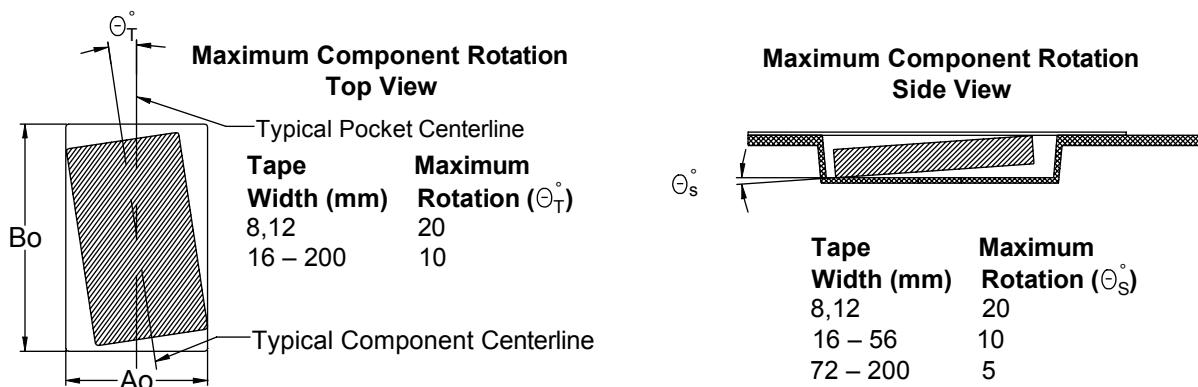


Figure 3 – Maximum Lateral Movement

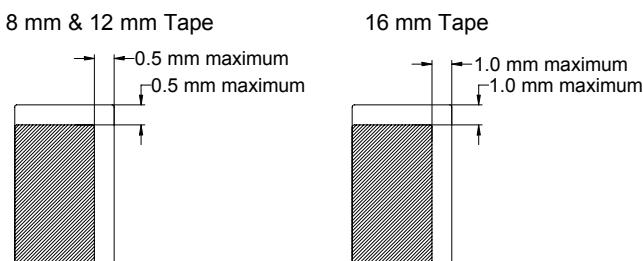


Figure 4 – Bending Radius

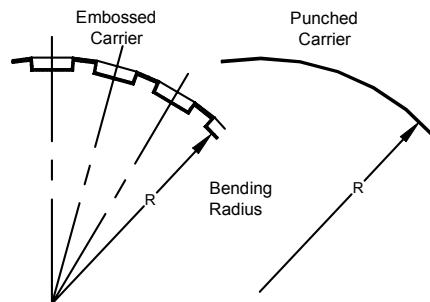
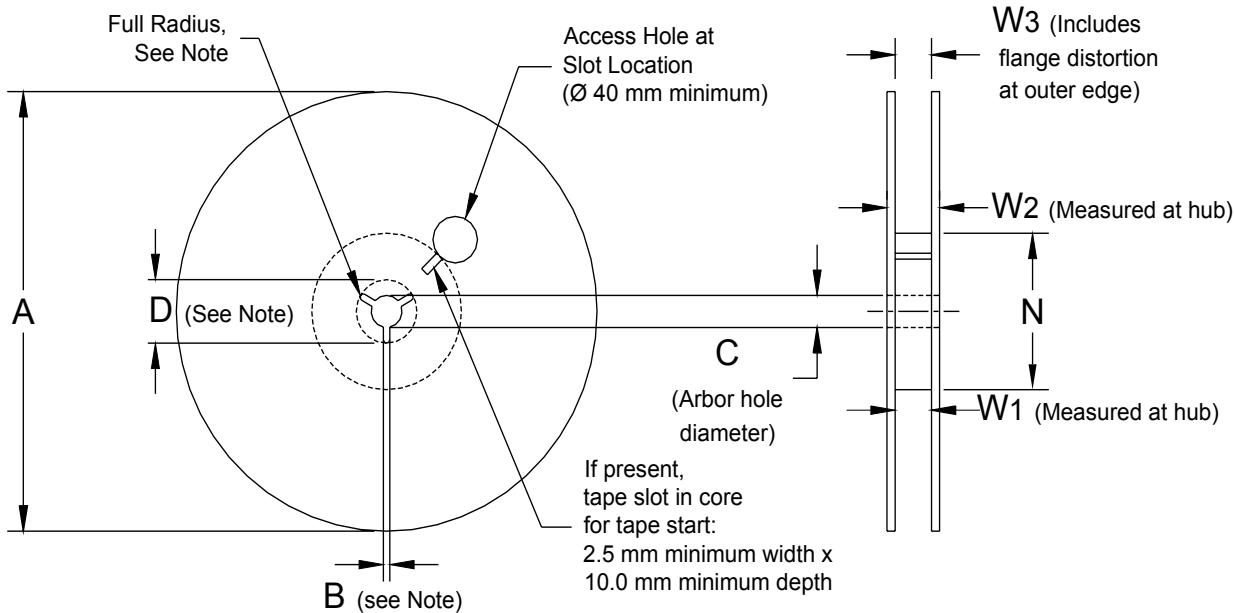


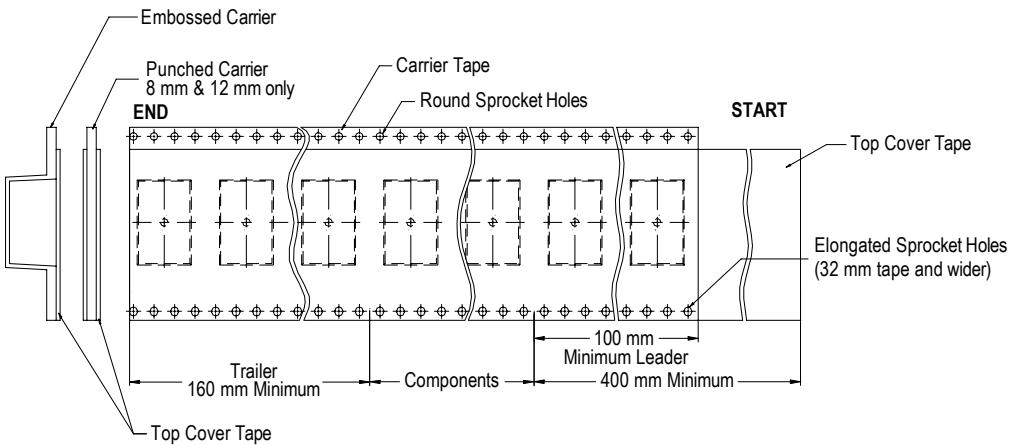
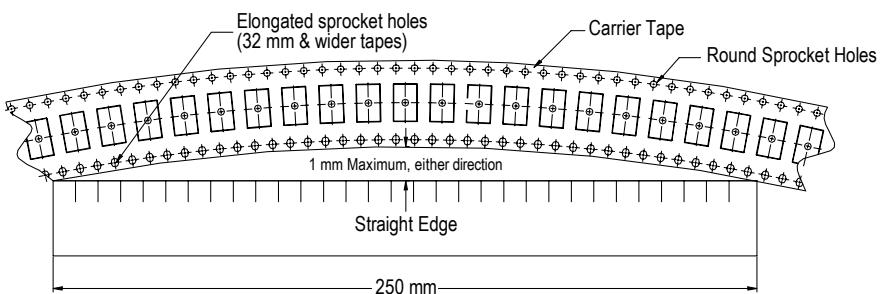
Figure 5 – Reel Dimensions

Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 5 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)				
Tape Size	A	B Minimum	C	D Minimum
8 mm	178 ± 0.20 (7.008 ± 0.008)	1.5 (0.059)	$13.0 \pm 0.5/-0.2$ ($0.521 \pm 0.02/-0.008$)	20.2 (0.795)
12 mm	or			
16 mm	330 ± 0.20 (13.000 ± 0.008)			
Variable Dimensions — Millimeters (Inches)				
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃
8 mm	50 (1.969)	$8.4 \pm 1.5/-0.0$ ($0.331 \pm 0.059/-0.0$)	14.4 (0.567)	Shall accommodate tape width without interference
12 mm		$12.4 \pm 2.0/-0.0$ ($0.488 \pm 0.078/-0.0$)	18.4 (0.724)	
16 mm		$16.4 \pm 2.0/-0.0$ ($0.646 \pm 0.078/-0.0$)	22.4 (0.882)	

Figure 6 – Tape Leader & Trailer Dimensions**Figure 7 – Maximum Camber**

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Tel: 52-33-3123-2141

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Tel: 33-1-4646-1006

Sasso Marconi, Italy
Tel: 39-051-939111

Central Europe
Landsberg, Germany
Tel: 49-8191-3350800

Kamen, Germany
Tel: 49-2307-438110

Northern Europe
Bishop's Stortford, United Kingdom
Tel: 44-1279-460122

Espoo, Finland
Tel: 358-9-5406-5000

Asia

Northeast Asia
Hong Kong
Tel: 852-2305-1168

Shenzhen, China
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Beijing, China
Tel: 86-10-5829-1711

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